

Microwave Ceramics Filter

3-pole filter for WLL base station TX filter

Series/Type: S3B3/1/8

Ordering code: B69843N3527A270

Date: 2010-02-09

Version: P2

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Microwave Ceramics Filter	B69843N	3527A270
3-pole filter for WLL base station TX filter		S3B3/1/8
Preliminary data sheet		
Modification		
P1	07.11.05	Reichel

09.02.10

Reichel

Upgraded to new form

Application

P2

■ RF filter for WLL (Wireless Local Loop)

Features

- SMD filter consisting of coupled resonators with stepped impedances
- MgTiO₃-CaTiO₃ (ε_{Γ} = 21/TC_f = 0 ±10 ppm/K) with a coating of copper (10 μ m) and tin (>5 μ m)
- Excellent reflow solderability, no migration effect due to copper/tin metallization
- ESD insensivity and ESD protecting due to filter characteristics

Microwave Ceramics Filter

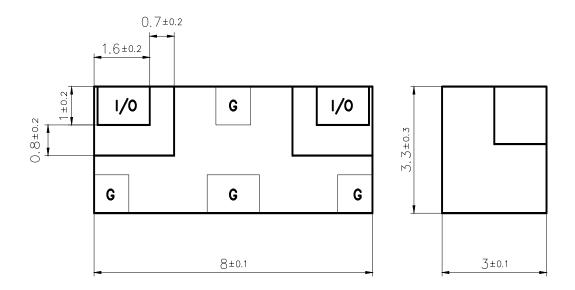
B69843N3527A270

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S3B3/1/8

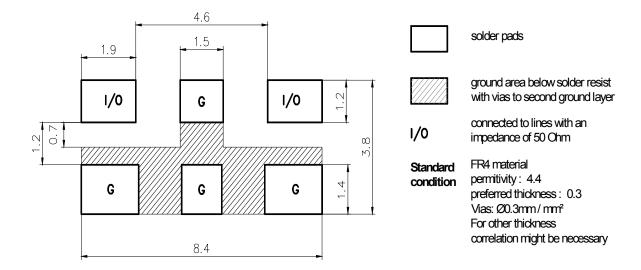
Preliminary data sheet

Component drawing



View from below onto the solder terminals and view from beside Marking: 'EPCOS logo '3527', on top of the filter

Recommended footprint





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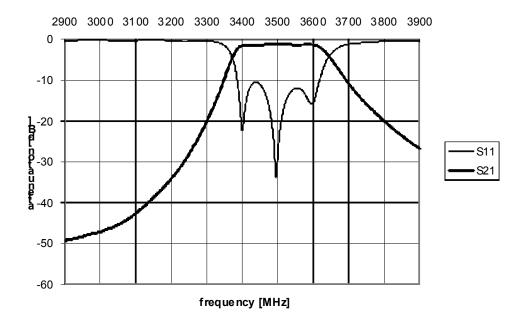
Characteristics

		min.	typ.	max.	
Center frequency	f _C	_	3525.0	_	MHz
Insertion loss	α L		1.1	1.4	dB
Passband	В	270			MHz
Amplitude ripple (peak – peak) at any 10 MHz BW	$\Delta \alpha$			0.4	dB
Standing wave ratio	SWR		1.5	2.0	
Impedance	Z		50		Ω
Power	Р			1.0	W
Attenuation	α				
at 2588 to 2738 MHz		46	48		dB
at 2944 to 3119 MHz		32	35		dB
at 3856 to 4031 MHz		17	19		dB
at 6800 to 7150 MHz		t.b.d*			dB

Maximum ratings

IEC climatic category (IEC 68-1)		-40 °C/+90 °C/56	
Operating temperature	T _{op}	-40/+85	°C

Typical passband characteristic



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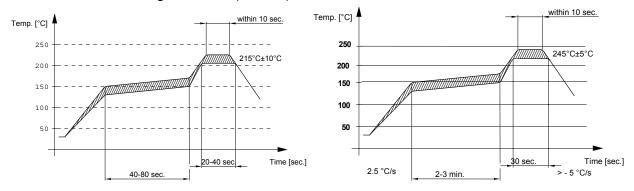
Processing information

Wettability acc. to IEC 68-2-58: ≥ 75% (after aging)

Soldering requirements

	Profile for eutectic SnPb solder paste	Profile for leadfree solder paste	
Soldering type	reflow	reflow	
Maximum soldering temperature	235 (max. 2 sec.)	260 (max. 2 sec.)	°C
(measuring point on top surface of the component)	225 (max. 10 sec.)	250 (max. 10 sec.)	°C

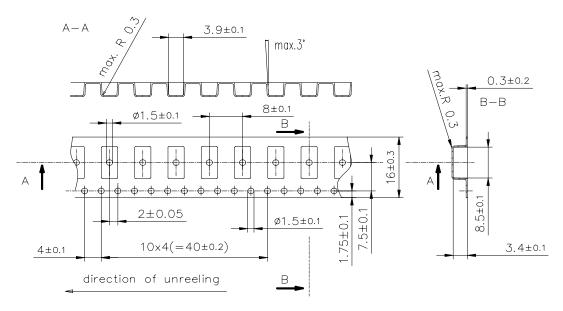
Recommended soldering conditions (infrared):



Delivery mode

■ Blister tape acc. to IEC 286-3, PS, grey

■ Pieces/tape: 2000





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